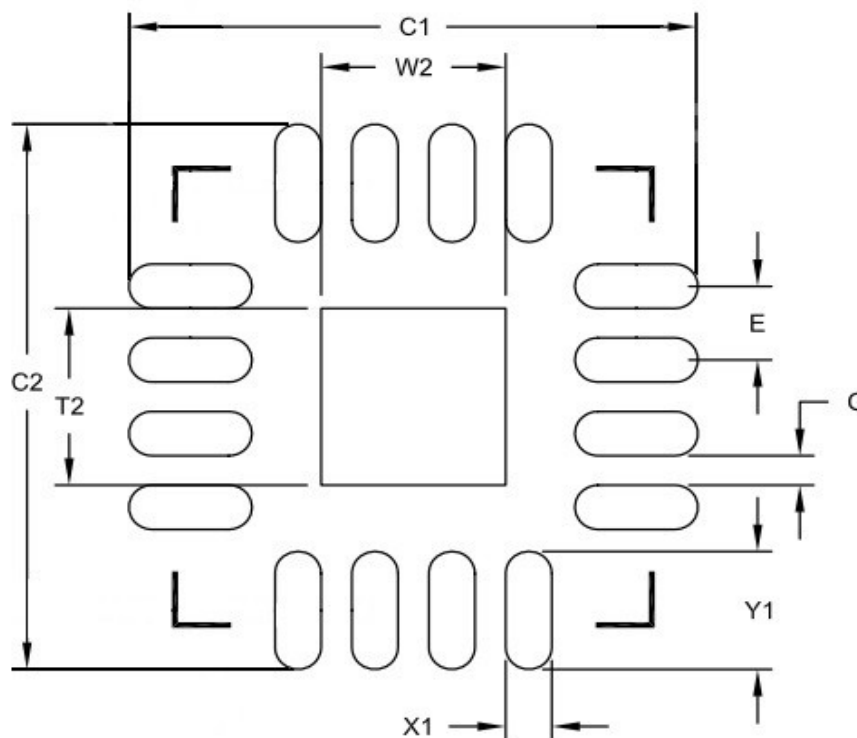


QFN16 6x6mm 1.0mm - stencil

Units		MILLIMETERS		
Dimension Limit		MIN	NOM	MAX
Contact Pitch	E		1.00	
Contact Pad Spacing	C1,C2		7.80	
Contact Pad Width	X1		0.50	
Contact Pad Length	Y1		1.40	
Distance Between Pads	G		0.50	
Optional Center Pad Width	T2		2.90	
Optional Center Pad Length	T2		2.90	

Top View (SMD Footprint)



Stencil dimensions: 38mm x 28mm

Thickness: 100-127 μ m

Material: stainless steel or nickel silver

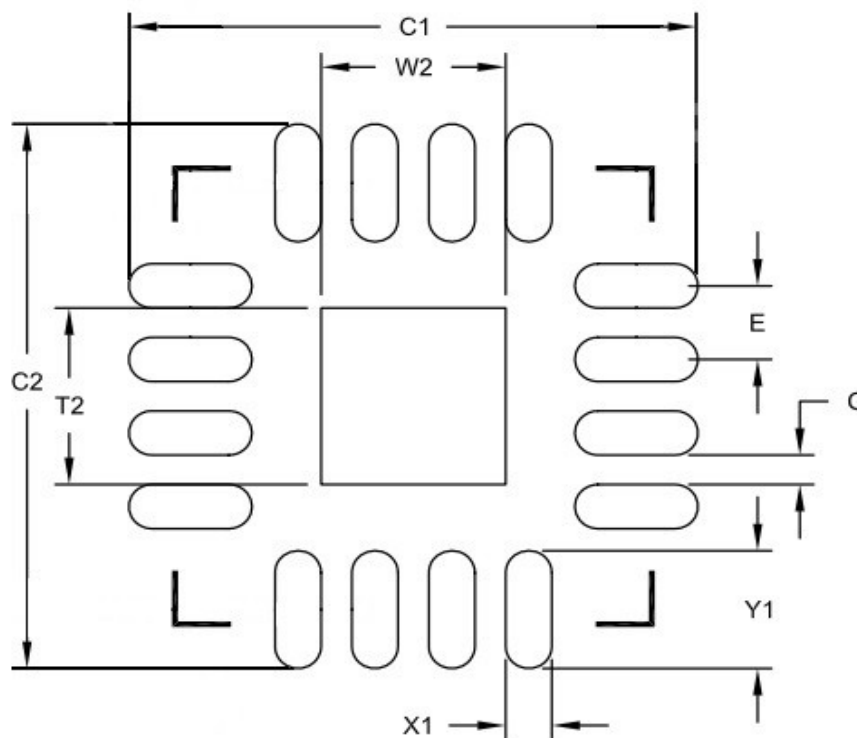
Manufacturing processes: lasering or chemical etching

Datasheet rev.: 1.04

QFN16 4x4mm 0.65mm - stencil

Units		MILLIMETERS		
Dimension Limit		MIN	NOM	MAX
Contact Pitch	E		0.65	
Contact Pad Spacing	C1,C2		4.30	
Contact Pad Width	X1		0.23	
Contact Pad Length	Y1		0.65	
Distance Between Pads	G		0.42	
Optional Center Pad Width	T2		1.60	
Optional Center Pad Length	T2		1.60	

Top View (SMD Footprint)



Stencil dimensions: 38mm x 28mm

Thickness: 100-127 μ m

Material: stainless steel or nickel silver

Manufacturing processes: lasering or chemical etching